TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MZ245FK

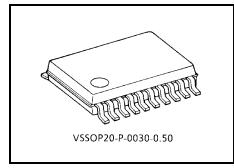
Low Voltage Octal Bus Transceiver with 5 V Tolerant Inputs and Outputs

The TC7MZ245FK is a high performance CMOS octal bus transceiver. Designed for use in $3.3\ V$ systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (3.3 V) V_{CC} applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

The direction of data transmission is determined by the level of the DIR input. The enable input (\overline{OE}) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.03 g (typ.)

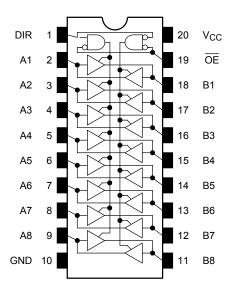
Features

- Low voltage operation: $V_{CC} = 2.0 \sim 3.6 \text{ V}$
- High speed operation: $t_{pd} = 7.0 \text{ ns (max) (V}_{CC} = 3.0 \sim 3.6 \text{ V)}$
- Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: -500 mA
- Package: VSSOP (US20)
- Bidirectional interface between 3.3 V and 5.0 V signals.
- Power down protection is provided on all inputs and outputs.
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 245 type.

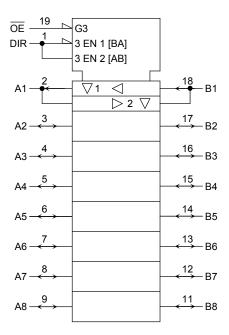
Note: Do not apply a signal to any bus terminal when it is in the output mode. Damage may result.

All floating (high impedance) bus terminals must have their input levels fixed by means of pull up or pull down resistors.

Pin Assignment (top view)



IEC Logic Symbol



Truth Table

Inputs		Outputs	Function		
ŌĒ	DIR	Outputs	A-Bus	B-Bus	
L	L	A = B	Output	Input	
L	Н	B=A	Input	Output	
Н	Х	Z	High Im	pedance	

X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit	
Supply voltage range	V _{CC}	-0.5~7.0	V	
DC input voltage (DIR, OE)	V _{IN}	-0.5~7.0	V	
DC bus I/O voltage	Vuo	−0.5~7.0 (Note 2)	V	
De bus 1/O Voltage	V _{I/O}	-0.5~V _{CC} + 0.5 (Note 3)		
Input diode current	I _{IK}	-50	mA	
Output diode current	lok	±50 (Note 4)	mA	
DC output current	lout	±50	mA	
Power dissipation	P_{D}	180	mW	
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA	
Storage temperature	T _{stg}	-65~150	°C	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in off-state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: $V_{OUT} < GND, V_{OUT} > V_{CC}$

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	2.0~3.6	V	
Supply voltage	VCC	1.5~3.6 (Note 2)	V	
Input voltage (DIR, $\overline{\mbox{OE}}$)	V _{IN}	0~5.5	V	
Bus I/O voltage	V _{I/O}	0~5.5 (Note 3)	V	
Bus I/O Vollage	V 1/O	0~V _{CC} (Note 4)	V	
Output gurrant	1/1	±24 (Note 5)	A	
Output current	IOH/IOL	±12 (Note 6)	mA	
Operating temperature	T _{opr}	-40~85	°C	
Input rise and fall time	dt/dv	0~10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either VCC or GND. Please connect both bus inputs and the bus outputs with VCC or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note 2: Data retention only

Note 3: Output in off-state

Note 4: High or low state

Note 5: $V_{CC} = 3.0 \sim 3.6 \text{ V}$

Note 6: $V_{CC} = 2.7 \sim 3.0 \text{ V}$

Note 7: $V_{IN} = 0.8 \sim 2.0 \text{ V}, V_{CC} = 3.0 \text{ V}$

Electrical Characteristics

DC Characteristics ($Ta = -40 \sim 85$ °C)

Characteristics		Cumahal	mbol Test Condition			Min	May	Lleit
		Symbol	10	rest Condition			Max	Unit
Input voltage	High level	V _{IH}		_	2.7~3.6	2.0	_	V
Input voltage	Low level	V _{IL}		_	2.7~3.6	_	8.0	V
			$I_{OH} = -100 \mu A$	2.7~3.6	V _{CC} - 0.2			
	High level	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -12 \text{ mA}$	2.7	2.2	_	٧
				$I_{OH} = -18 \text{ mA}$	3.0	2.4	_	
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2	_	
	V	VIN = VIH OF VII	I _{OL} = 100 μA	2.7~3.6	_	0.2		
			I _{OL} = 12 mA	2.7	_	0.4		
	Low level	V _{OL}	AIV = AIH OL AIL	I _{OL} = 16 mA	3.0	_	0.4	
				I _{OL} = 24 mA	3.0	_	0.55	
Input leakage current I _{IN}		I _{IN}	V _{IN} = 0~5.5 V		2.7~3.6		±5.0	μΑ
2 state output of	ff atata aurrant	1	$V_{IN} = V_{IH}$ or V_{IL}		2.7~3.6		.50	^
3-state output off-state current		loz	V _{OUT} = 0~5.5 V		2.7~3.0	_	±5.0	μΑ
Power off leaka	ge current	l _{OFF}	V _{IN} /V _{OUT} = 5.5 V		0		10.0	μΑ
Quiescent supply current		laa	V _{IN} = V _{CC} or GND		2.7~3.6	_	10.0	
		Icc	V _{IN} /V _{OUT} = 3.6~5.5 V		2.7~3.6		±10.0	μΑ
Increase in I _{CC}	crease in I _{CC} per input △I _{CC}		V _{IH} = V _{CC} - 0.6 V		2.7~3.6		500	

AC Characteristics ($Ta = -40 \sim 85$ °C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Drangation delay time	t _{pLH}	Figure 1 Figure 2	2.7	_	8.0	20
Propagation delay time	t_{pHL}	Figure 1, Figure 2	3.3 ± 0.3	1.5	7.0	ns
Output enable time	t _{pZL}	Figure 1, Figure 3	2.7	_	9.5	ns
Output enable time	t _{pZH}		3.3 ± 0.3	1.5	8.5	
Output disable time	t_{pLZ}	Figure 1, Figure 3	2.7		8.5	ns
Output disable time	t _{pHZ}	rigure 1, rigure 3	3.3 ± 0.3	1.5	7.5	115
Output to output skew	t _{osLH}	(Note)	2.7	_		ns
Output to output sitew	t _{osHL}	(Note)	3.3 ± 0.3	_	1.0	113

Note: This parameter is guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$

Dynamic Switching Characteristics

(Ta = 25°C, Input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V

Capacitive Characteristics (Ta = 25°C)

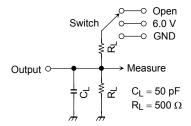
Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	CIN	DIR, OE	3.3	7	pF
Bus input capacitance	C _{I/O}	A _n , B _n	3.3	8	pF
Power dissipation capacitance	C _{PD}	$f_{IN} = 10 \text{ MHz}$ (No	e) 3.3	25	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$

AC Test Circuit



Parameter	Switch
t _{pLH} , t _{pHL}	Open
t _{pLZ} , t _{pZL}	6.0 V
t _{pHZ} , t _{pZH}	GND

Figure 1

AC Waveform

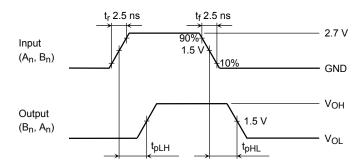


Figure 2 t_{pLH}, t_{pHL}

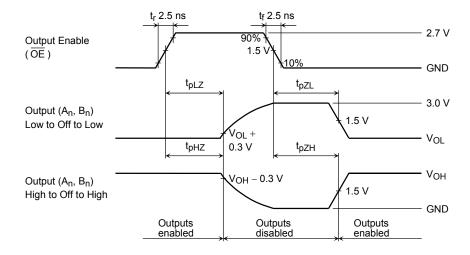
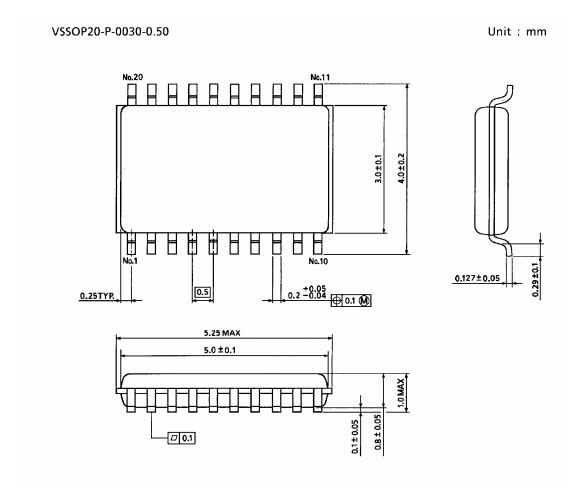


Figure 3 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

Package Dimensions



Weight: 0.03 g (typ.)

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